L Number	Hits	Search Text	DB	Time stamp
-	18	((integrated near3 circuit near3 design) or (IC near3	USPAT;	2002/07/22 14:37
		design) or (semiconductor near3 device)) and module	US-PGPUB;	
		and (wir\$3 near3 layer) and ((horizontal and vertical	EPO; JPO;	+
		and diagonal) near3 direction)	DERWENT;	1
		,	IBM TDB	
	1	((integrated near3 circuit near3 design) or (IC near3	USPAT;	2002/07/22 16:01
	•	design) or (semiconductor near3 device)) and module	US-PGPUB;	i i
		and (wir\$3 near3 layer near3 (multipl\$3 or plural\$3))	EPO; JPO;	ŧ .
		and ((horizontal and vertical and diagonal) near3	DERWENT;	i i
			IBM_TDB	!
	•	direction)	USPAT;	2002/07/22 16:06
	1	((integrated near3 circuit near3 design) or (IC near3	US-PGPUB;	2002/01/22 10.00
		design) or (semiconductor near3 device)) and module		!
		and (wir\$3 near3 layer near3 (multipl\$3 or plural\$3 or	EPO; JPO;	•
		multilayer or (mult\$3 near3 layer))) and ((horizontal	DERWENT;	•
		and vertical and diagonal) near3 direction)	IBM_TDB	
	15	((integrated near3 circuit near3 design) or (IC near3	USPAT;	2002/07/22 16:31
		design) or (semiconductor near3 device)) and module	US-PGPUB;	
		and ((mult\$3 or plural\$3) near3 layer) and ((horizontal	EPO; JPO;	İ
		and vertical and diagonal) near3 direction)	DERWENT;	i ·
		, , ,	IBM TDB	
_	17	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/22 16:39
		and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	
		((horizontal and vertical and diagonal) near3	EPO; JPO;	
*		direction)	DERWENT:	
		direction)	IBM TDB	·
	1000	((intermeted mean) circuit) on IC on comiconductor)	USPAT;	2002/07/22 16:42
	1236	((integrated near3 circuit) or IC or semiconductor)		2002/01/22 10.4
		and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	
		((five or fifth) near3 layer) ((horizontal and vertical	EPO; JPO;	1
		and diagonal) near3 direction)	DERWENT;	!
			IBM_TDB	
	366	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/22 16:44
		and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	i
		((five or fifth) near3 layer) ((horizontal and vertical	EPO; JPO;	
		and diagonal) near3 direction) and (gridless near3 non	DERWENT;	:
		near3 manhattan)	IBM TDB	
	2	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/22 16:49
	_	and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	1
		((five or fifth) near3 layer near3 metal near3 wir\$3)	EPO; JPO;	
		((horizontal and vertical and diagonal) near3	DERWENT;	1
		direction) and (gridless near? non near? manhattan)	IBM TDB	i
		direction) and (gridless near3 non near3 manhattan)	ואומו דאומו	i
i	200	and orthogonal	HCDAT.	. 2002/07/22 08:23
•	366	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/23 08:23
		and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	
		((five or fifth) near3 layer) ((horizontal and vertical	EPO; JPO;	
		and diagonal) near3 direction) and (gridless near3 non	DERWENT;	
		near3 manhattan) and orthogonal	IBM_TDB	1
	0	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/23 08:2
		and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	1
		((five or fifth) near3 layer) and ((horizontal and	EPO; JPO;	;
		vertical and diagonal) near3 direction) and (gridless	DERWENT;	
		near3 non near3 manhattan) and orthogonal	IBM TDB	
	15	((integrated near3 circuit) or IC or semiconductor)	USPAT;	2002/07/23 08:5
	10	and module and ((mult\$3 or plural\$3) near3 layer) and	US-PGPUB;	1 2002/01/20 00:0
			EPO; JPO;	
		((five or fifth) near3 layer) and ((horizontal and		1
ļ		vertical and diagonal) near3 direction)	DERWENT;	•
			IBM_TDB	
•	148	((non near3 manhattan) or nonmanhattan or diagonal)	USPAT;	2003/01/14 10:1
		near3 wiring	US-PGPUB;	
			EPO; JPO;	;
			DERWENT;	1
			IBM TDB	1

				, , , , , , , , , , , , , , , , , , , ,
-	2	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/06 15:42
		diagonal) near3 wiring) and gridless	US-PGPUB;	+
			EPO; JPO;	i
			DERWENT;	t
			IBM_TDB	
-	19	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/06 15:43
	İ	diagonal) near3 wiring) and manhattan	US-PGPUB;	•
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	1
-	19	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/18 17:11
	•	diagonal) near3 wiring) and manhattan and layers	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	i
			IBM TDB	
-	2	(manhattan same gridded) and layers	USPAT;	2003/03/07 07:44
		, ,	US-PGPUB;	!
			EPO; JPO;	
			DERWENT;	
+			IBM TDB	
_	74	(manhattan and grid\$4) and (metal near3 layer)	USPAT;	2003/03/07 07:45
	, 1	(mammattan and griddi) and (metar nears layer)	US-PGPUB;	1
			EPO; JPO;	1
			DERWENT;	!
			IBM TDB	i
	51	(manhattan and grid\$4) and (matal near? layer) and	USPAT;	2003/03/07 07:46
-	31	(manhattan and grid\$4) and (metal near3 layer) and	US-PGPUB;	2003/03/07/07.40
		(first near3 layer)		
			EPO; JPO;	· •
			DERWENT;	
	0.0		IBM_TDB	2002/02/07 00 21
-	36	(manhattan and grid\$4) and (metal near3 layer) and	USPAT;	2003/03/07 09:21
		(first near3 layer) and (fourth near3 layer)	US-PGPUB;	1
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/00/07/00
-	13	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 09:29
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	
		((manhattan and grid\$4) and (metal near3 layer) and	EPO; JPO;	
		(first near3 layer) and (fourth near3 layer))	DERWENT;	
			IBM_TDB	
-	7	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 09:06
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	
	17	((manhattan and grid\$4) and (metal near3 layer) and	EPO; JPO;	•
		(first near3 layer) and (fourth near3 layer)) and pitch	DERWENT;	
1			IBM_TDB	i I
-	9	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 09:15
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	
		pitch	EPO; JPO;	
			DERWENT;	: :
			IBM TDB	T.
_	15	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 09:23
	10	diagonal) near3 wiring) and (manhattan or grid\$4)	US-PGPUB;	. 2000/00/01 00:20
		and (metal near3 layer) and (first near3 layer) and	EPO; JPO;	
	1	(fourth near3 layer)	DERWENT;	1
		(Tour tit floats tayer)	IBM_TDB	:
	9	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 11:34
-	9	diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	:
			1	1
		pitch	EPO; JPO;	
			DERWENT;	1 .
			IBM_TDB	

-	0	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/03/07 11:45
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	•
		((first near3 layer) near3 horizint\$3) and ((second	EPO; JPO;	1
		near3 layer) near3 vertic\$3) and ((third near3 layer)	DERWENT;	
		near3 diagon\$3) and ((fourth near3 layer) near3	IBM_TDB	1
	0	diagon\$3) ((first near3 layer) near3 horizint\$3) and ((second	USPAT;	2003/03/07 11:38
-	0	near3 layer) near3 vertic\$3) and ((third near3 layer)	US-PGPUB;	2003/03/07 11.30
		near3 diagon\$3) and ((fourth near3 layer) near3	EPO; JPO;	!
		diagon\$3)	DERWENT;	!
]	augonwo)	IBM TDB	
_	0	((first near3 layer) near3 horizont\$3) and ((second	USPAT;	2003/03/07 11:38
		near3 layer) near3 vertic\$3) and ((third near3 layer)	US-PGPUB;	1
		near3 diagon\$3) and ((fourth near3 layer) near3	EPO; JPO;	
		diagon\$3)	DERWENT;	1
			IBM_TDB	i .
-	16	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/18 17:04
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	1
		(horizontal and vertical and diagonal)	EPO; JPO;	1
			DERWENT;	
		(//	IBM_TDB	2002/02/07 12:12
-	8	(((non near3 manhattan) or nonmanhattan or	USPAT; US-PGPUB;	2003/03/07 12:12
		diagonal) near3 wiring) and manhattan and layers and (layer near3 (horizontal and vertical and diagonal))	EPO; JPO;	
		(layer flears (florizofital and vertical and diagonal))	DERWENT;	!
			IBM TDB	•
_	11	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/18 16:59
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	
		(horizontal and vertical and diagonal) and	EPO; JPO;	
		@pd<=20030115	DERWENT;	:
			IBM_TDB	
-	11	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/18 17:04
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	٠.
		(horizontal and vertical and diagonal) and	EPO; JPO;	:
		@pd<=20030115	DERWENT;	
	,,	(//	IBM_TDB	. 2002/04/19 17:05
-	11	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/18 17:05
		diagonal) near3 wiring) and manhattan and layers and (horizontal and vertical and diagonal) and	US-PGPUB; EPO; JPO;	T
		@pd<=20030115	DERWENT;	
		@pu \-20000110	IBM TDB	·
_	14	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/22 09:32
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	;
		@pd<=20030115	EPO; JPO;	#
			DERWENT;	
			IBM_TDB	1
-	0	simulated adj1 euclidean adj1 wiring	USPAT;	2003/04/21 15:30
			US-PGPUB;	
			EPO; JPO;	i .
			DERWENT;	
		ainentakad maan0 analidaan oo anoo siisisa	IBM_TDB	2002/04/21 15 22
-	0	simulated near2 euclidean near2 wiring	•	2003/04/21 15:30
			US-PGPUB;	
			EPO; JPO; DERWENT;	:
			IBM TDB	
_	0	euclidean near3 wir\$3	USPAT;	2003/04/21 16:22
-	"	Cachacan near o whyo	US-PGPUB;	1 2000/01/21 10:22
			EPO; JPO;	!
			DERWENT;	1
			IBM_TDB	,
			·	

-	0	euclidean near3 wiring	USPAT;	2003/04/21 16:42
			US-PGPUB;	•
			EPO; JPO;	•
			DERWENT,	
			IBM TDB	i
	0	(euclidean near3 (wiring or wir\$3 or distance)) same	USPAT;	2003/04/21 16:43
		(integrated near3 circuit)	US-PGPUB;	i
		(integrated near o en early	EPO; JPO;	
			DERWENT;	I
			IBM TDB	:
	1		USPAT;	2003/04/21 16:49
	1		US-PGPUB	1
	0		USPAT;	2003/04/21 16:56
	0		US-PGPUB	2003/04/21 10.30
	0		i	2002/04/21 16.55
	0		USPAT;	2003/04/21 16:55
			US-PGPUB	2002/04/21 10 55
	0		USPAT;	2003/04/21 16:55
			US-PGPUB	
	0		USPAT;	; 2003/04/21 16:55
			US-PGPUB	
	0		USPAT;	2003/04/21 16:55
			US-PGPUB	·
	1		USPAT;	2003/04/21 16:55
			US-PGPUB	!
	0		USPAT;	2003/04/21 16:55
			US-PGPUB	1
	1	20010009031.pn.	USPAT;	2003/04/21 16:56
			US-PGPUB	1
	1		USPAT;	2003/04/21 17:00
	•		US-PGPUB	. 2000/01/21 17:00
	0	((non noar? manhattan) or nonmanhattan or	USPAT;	2003/04/22 09:35
	U	(((non near3 manhattan) or nonmanhattan or		1 2003/04/22 05.33
		diagonal) near3 wiring) and manhattan and layers and	US-PGPUB;	
		(ratio same ((first and second) near3 line))	EPO; JPO;	!
			DERWENT;	!
	_		IBM_TDB	
-	0	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/22 09:35
		diagonal) near3 wiring) and layers and (ratio same	US-PGPUB;	•
		((first and second) near3 line))	EPO; JPO;	1
			DERWENT;	
			IBM_TDB	: 1
	17	(((non near3 manhattan) or nonmanhattan or	USPAT;	2003/04/22 14:17
		diagonal) near3 wiring) and layers and (ratio same	US-PGPUB;	!
		length)	EPO; JPO;	!
			DERWENT:	
			IBM TDB	1
	23	((((non near3 manhattan) or nonmanhattan or	-	. 2003/04/22 14:18
		diagonal) near3 wiring) same ratio) and layers	US-PGPUB;	1
		ambonar, near o wiring, same ratio, and rayers	EPO; JPO;	1
			DERWENT;	i
				:
			IBM TDB	1

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